

Final Product/Mterial Change Notification Document #: WOM PCN Issue Date: 2020/4/20 PCN#: 2020042002RB15

			PCN#: 2020042002RB15			
Title of Change:		Rectron WOM package PCN				
Proposed first ship date						
Contact information:		Please contact Rectron Semiconductor Sales Office or visit www.rectron.com for nearest contact information.  Please contact Rectron Semiconductor Sales Office or visit www.rectron.com for nearest contact information.  Samples delivery timing will be subject to request date, sample quantity and special customer packing/label requirements.				
Samples:						
Additional Reliability Data:		Please contact Rectron Semiconductor Sales Office or visit www.rectron.com for nearest contact information.  This is a Final Product/Process Change Notification (FPCN) sent to customers. FPCNs are issued 90 days				
Type of notification:		Rectron Semiconducto	prior to implementation of the change.  Rectron Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days ofdelivery of this notice. To do so,Please visit www.rectron.com for nearest contact information			
Change Part Identification:		Model unchanged	Model unchanged			
Change Category:		☐ Material ■Machine	□ Material ■Machine/Tooling □Method □Manufacture site □Man			
Change Sub-Category(s):		□ Manufacturing Site Transfer       □ Material Change         ■ Datasheet/Product Doc change       □ Manufacturing Process Change       □ Product specific change       □ Shipping/Packaging/Marking         □ Manufacturing Site Addition       □ Other:				
Last order date for old parts  Description and Purpose:			About Rectron WOM package. , old molding tools phase in .			
Point:	Change	Before change D	escription	After	change Description	
1.Body height 2.Body length	Old max 7.4mm, min 9.5mm new max 3.8mm, min 3.3mm Old max 10mm, min 9.5mm new max 9.1mm, min 8.6mm	2 350 ( 340 (	0.75 (19.0) MIN.	2 150 (3.8) 130 (3.3) 1.2 (30.5) MIN.	380 (9.1) 340 (8.6) 1 1.0 (25.4) MIN.	
		POS. LEAD	.032 (0.8) .028 (0.7)	POS. LEAD +	220 (5.6) 	

Reliability Data Summary:							
QV DEVICE NAME:							
Hi-real test	Sample size( PC)	Condition	ACC/REJ				
igh Temperature Reverse Bia	77	Ta=150°C±5°C VR=480V. for 1000 Hrs.	ACC				
Thermal Fatigue Testing	77	ON: 300 sec / Off: 300 sec for 1000 cycles	ACC				
Solder resistance	77	260±5°C for 10±2 Sec.	ACC				
Thermal Shock	77	55°C±5°C/5MIN AND 150±5°C/5MIN for 100 cycles	ACC				
Electrical Characteristic		Electrical characteristics are not impacted					
List of Affected Parts:		Note: Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customerspecific PCN addendum in the PCN email notification, or on the PCN Customized Portal.					
Part Number		Addition	Mark				
W005M W01M W02M W04M W06M W08M W10M		Including to House #					
2W10G		Including to House #					
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